



Docket No.: 50352-020

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 20277
Shiroshi MATSUKI, et al.	:	Confirmation Number: 9915
Serial No.: 09/944,344	:	Group Art Unit: 1753
Filed: September 04, 2001	:	Examiner: Edna Wong

For: MATERIAL FOR COPPER ELECTROPLATING, METHOD FOR
MANUFACTURING SAME AND COPPER ELECTROPLATING METHOD

PETITION FOR EXTENSION OF TIME


Mail Stop Extension of Time
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

It is respectfully requested that the time for response to the Office Action dated December 11, 2003, now due to expire March 11, 2003, be extended for two month(s) and set to expire on June 11, 2003. Please charge the extension fee of \$930.00 to Deposit Account No. 500417. Please charge any additional fees or credit any overpayment to Deposit Account No. 500417.

Respectfully submitted,

MCDERMOTT, WILL & EMERY


Daniel Bucca, Ph.D.

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